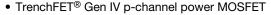
Vishay Siliconix

# P-Channel 80 V (D-S) MOSFET



PRODUCT SUMMARY					
V <sub>DS</sub> (V)	-80				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = -10 \text{ V}$	0.0193				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = -4.5 \text{ V}$	0.027				
Q <sub>g</sub> typ. (nC)	19.3				
I <sub>D</sub> (A)	-46				
Configuration	Single				

#### **FEATURES**





• Very low R<sub>DS(on)</sub> minimizes voltage drop and reduces conduction loss

RoHS COMPLIANT HALOGEN **FREE** 

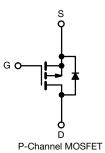
Eliminates the need for charge pump

100 % R<sub>a</sub> and UIS tested

 Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### **APPLICATIONS**

- · Adapter and charger switch
- · Battery and circuit protection
- OR-ing
- · Load switch
- Motor drive control



ORDERING INFORMATION	
Package	PowerPAK SO-8
Lead (Pb)-free and halogen-free	Si7469ADP-T1-RE3

<b>ABSOLUTE MAXIMUM RATING</b>	<b>S</b> (T <sub>A</sub> = 25 °C, u	inless other	wise noted)	
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V <sub>DS</sub>	-80	V
Gate-source voltage		$V_{GS}$	+20 / -20	v
	T <sub>C</sub> = 25 °C		-46	
Continuous drain augrent /T 150 °C)	T <sub>C</sub> = 70 °C	1 .	-36.8	
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	l <sub>D</sub>	-7.4 <sup>b, c</sup>	
	T <sub>A</sub> = 70 °C	1	-5.9 b, c	•
Pulsed drain current (t = 100 μs)		I <sub>DM</sub>	-125	A
Cartinua de de de comant	T <sub>C</sub> = 25 °C	_	-66.8	
Continuous source-drain diode current	T <sub>A</sub> = 25 °C	- I <sub>S</sub>	-4.5 b, c	
Single pulse avalanche current	L = 0.1 mH	I <sub>AS</sub>	-40	
Single pulse avalanche energy	L = U.1 MH	E <sub>AS</sub>	-80	mJ
	T <sub>C</sub> = 25 °C		73.5	
Maximum power dissipation	T <sub>C</sub> = 70 °C	1 5	47	147
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	5 b, c	W
	T <sub>A</sub> = 70 °C	1	3.2 b, c	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Soldering recommendations (peak temperature) c		İ	260	

THERMAL RESISTANCE RATI	NGS				
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient <sup>b</sup>	t ≤ 10 s	R <sub>thJA</sub>	20	25	°C/W
Maximum junction-to-case (drain)	Steady state	$R_{thJC}$	1.35	1.7	]

Notes
a. Package limited
b. Surface mounted on 1" x 1" FR4 board
c. t = 10 s
d. See solder profile (<a href="https://www.vishav.com/doc?73257">www.vishav.com/doc?73257</a>). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components
f. Maximum under steady state conditions is 65 °C/W
g. T<sub>C</sub> = 25 °C



www.vishay.com

# Vishay Siliconix

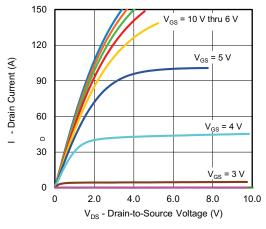
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static			•		•	
Drain-source breakdown voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-80	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = -10 mA	-	-83	-	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = -250 μA	-	4.1	-	mV/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	-1.4	-	-2.6	V
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = +20 \text{ / } -20 \text{ V}$	-	-	100	nA
Zana arata walta ara dualia awanant		$V_{DS} = -80 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	-10	μΑ
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = -80 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 70 °C	-	-	-50	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge -10 \text{ V}, V_{GS} = -10 \text{ V}$	-40	-	-	Α
During and the majetage 2	Б	$V_{GS} = -10 \text{ V}, I_D = -10 \text{ A}$	-	0.0161	0.0193	
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = -4.5 \text{ V}, I_D = -10 \text{ A}$	-	0.022	0.027	Ω
Forward transconductance a	9 <sub>fs</sub>	V <sub>DS</sub> = -15 V, I <sub>D</sub> = -10 A	-	34	-	S
Dynamic <sup>b</sup>			•		•	
Input capacitance	C <sub>iss</sub>		-	3420	-	
Output capacitance	C <sub>oss</sub>	$V_{DS} = -40 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	1050	-	pF
Reverse transfer capacitance	C <sub>rss</sub>		-	37	-	1
Table and a share a	0	$V_{DS} = -40 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -10 \text{ A}$	-	42.7	65	
Total gate charge	$Q_g$		-	19.3	29	0
Gate-source charge	Q <sub>gs</sub>	$V_{DS} = -40 \text{ V}, V_{GS} = -4.5 \text{ V}, I_D = -10 \text{ A}$	-	10.9	-	nC
Gate-drain charge	$Q_{gd}$		-	4.7	-	
Gate resistance	R <sub>g</sub>	f = 1 MHz	0.6	1.6	2.7	Ω
Turn-on delay time	t <sub>d(on)</sub>		-	14	28	
Rise time	t <sub>r</sub>	$V_{DD} = -40 \text{ V}, R_L = 4 \Omega, I_D \cong -10 \text{ A},$	-	9	18	
Turn-off delay time	t <sub>d(off)</sub>	$V_{DD} = -40 \text{ V, } R_L = 4  \Omega,  I_D \cong -10 \text{ A,}$ $V_{GEN} = -10 \text{ V, } R_g = 1  \Omega$		31	62	1
Fall time	t <sub>f</sub>		-	10	20	
Turn-on delay time	t <sub>d(on)</sub>		-	30	60	ns
Rise time	t <sub>r</sub>	$V_{DD} = -40 \text{ V}, \text{ R}_{L} = 4 \Omega, \text{ I}_{D} \cong -10 \text{ A},$	-	81	162	
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$	-	24	48	
Fall time	t <sub>f</sub>		-	14	28	
<b>Drain-Source Body Diode Characterist</b>	ics					
Continuous source-drain diode current	Is	T <sub>C</sub> = 25 °C	-	-	-66.8	
Pulse diode forward current	I <sub>SM</sub>		-	-	-125	Α
Body diode voltage	$V_{SD}$	$I_{S} = -5 \text{ A}, V_{GS} = 0 \text{ V}$	-	-0.78	-1.1	V
Body diode reverse recovery time	t <sub>rr</sub>		-	63	126	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	$I_F = -10 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	42	84	nC
Reverse recovery fall time	t <sub>a</sub>	$T_J = 25  ^{\circ}C$	-	25	-	
Reverse recovery rise time	t <sub>b</sub>		-	17	-	ns

#### **Notes**

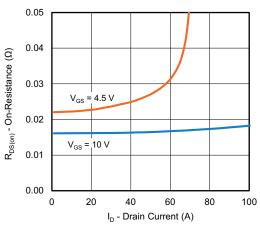
- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

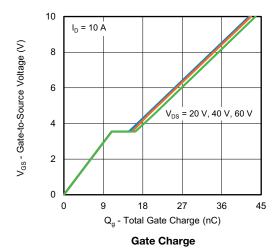


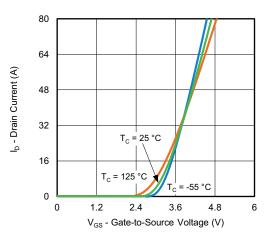


#### **Output Characteristics**

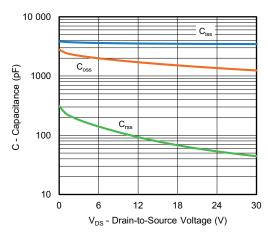


On-Resistance vs. Drain Current and Gate Voltage

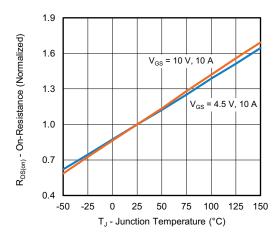




**Transfer Characteristics** 

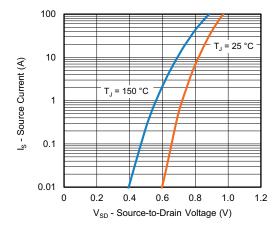


Capacitance

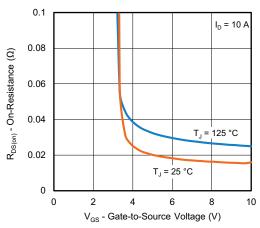


On-Resistance vs. Junction Temperature

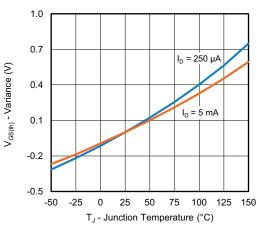




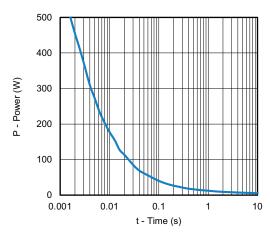
Source-Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage

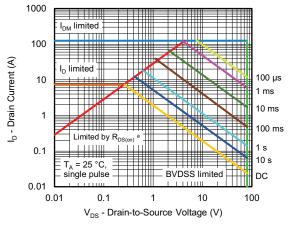


**Threshold Voltage** 



Single Pulse Power, Junction-to-Ambient

w.vishav.com/doc?91000

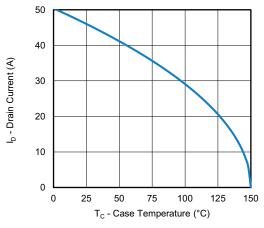


Safe Operating Area, Junction-to-Ambient

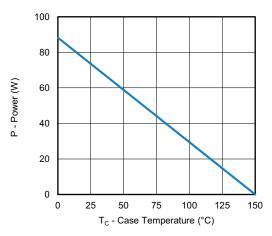
## Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

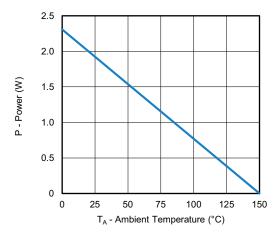




#### Current Derating a



Power, Junction-to-Case

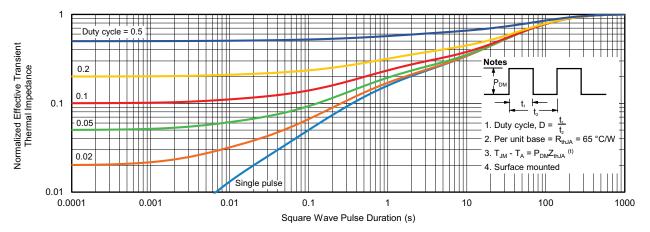


Power, Junction-to-Ambient

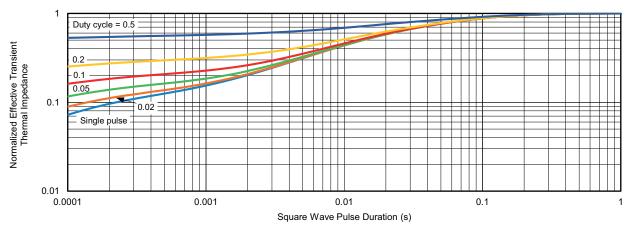
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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# PowerPAK® SO-8, (Single/Dual)



DIM.		MILLIMETERS			INCHES			
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX		
Α	0.97	1.04	1.12	0.038	0.041	0.044		
A1		-	0.05	0	-	0.002		
b	0.33	0.41	0.51	0.013	0.016	0.020		
С	0.23	0.28	0.33	0.009	0.011	0.013		
D	5.05	5.15	5.26	0.199	0.203	0.207		
D1	4.80	4.90	5.00	0.189	0.193	0.197		
D2	3.56	3.76	3.91	0.140	0.148	0.154		
D3	1.32	1.50	1.68	0.052	0.059	0.066		
D4		0.57 typ.		0.0225 typ.				
D5		3.98 typ.		0.157 typ.				
E	6.05	6.15	6.25	0.238	0.242	0.246		
E1	5.79	5.89	5.99	0.228	0.232	0.236		
E2	3.48	3.66	3.84	0.137	0.144	0.151		
E3	3.68	3.78	3.91	0.145	0.149	0.154		
E4		0.75 typ.			0.030 typ.			
е		1.27 BSC		0.050 BSC				
K		1.27 typ.		0.050 typ.				
K1	0.56	-	-	0.022	-	-		
Н	0.51	0.61	0.71	0.020	0.024	0.028		
L	0.51	0.61	0.71	0.020	0.024	0.028		
L1	0.06	0.13	0.20	0.002	0.005	0.008		
θ	0°	=	12°	0°	-	12°		
W	0.15	0.25	0.36	0.006	0.010	0.014		
M		0.125 typ.			0.005 typ.			

Revison: 13-Feb-17 1 Document Number: 71655



# RECOMMENDED MINIMUM PADS FOR PowerPAK® SO-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

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